Asymtek Automove 400 Under Fill Dispenser

DESCRIPTION:
• High speed computer controlled fluid dispensing system
• Printed Circuit Board applications include dispensing
  Solder masks and solder pastes
  SMT adhesives
• Adaptable to a variety of substrates for dispensing other fluids such as epoxies, potting compounds and RTV silicone
• X, Y, Z positioning system

LOCATION: PROCESS DESIGN AND ANALYSIS LABORATORY, ROOM B7

For more information or to arrange for the use of this equipment, contact any of the IEEC staff members listed below:

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